



Surface Mount General Purpose Silicon Rectifiers

Reverse Voltage - 50 to 1000 V

Forward Current - 5 A

FEATURES

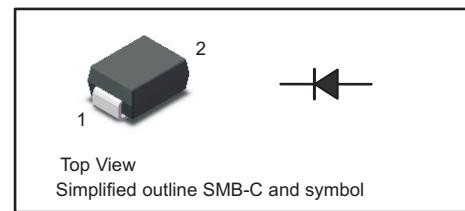
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMB-C
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.095g / 0.003oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	S5ABC	S5BBC	S5DBC	S5GBC	S5JBC	S5KBC	S5MBC	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @ Fig.1	I _{F(AV)}	5							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	200							A
Peak Forward Surge Current 1.0 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	400							A
I ² t Rating for fusing (3ms≤t≤8.3ms)	I ² t	166							A ² S
Maximum Instantaneous Forward Voltage at 5 A	V _F	1.1							V
Maximum DC Reverse Current T _a = 25 °C at Rated DC Blocking Voltage T _a = 125 °C	I _R	10 100							μA
Typical Junction Capacitance ⁽¹⁾	C _j	50							pF
Typical Thermal Resistance ⁽²⁾	R _{θJA} R _{θJC} R _{θJL}	43 9 18							°C/W
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150							°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 1.5" X 1.5" (3.81 X 3.81 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

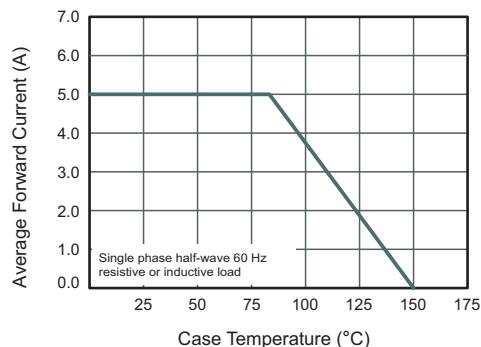


Fig.3 Typical Forward Characteristic

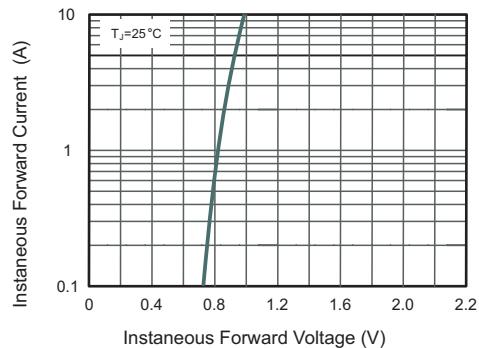


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current

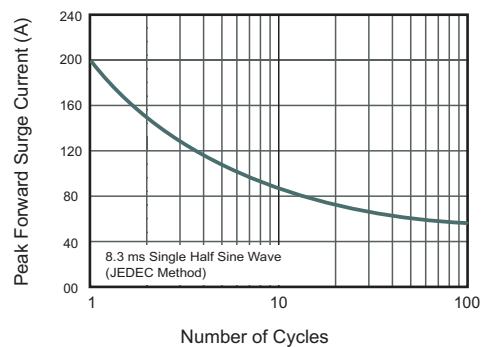


Fig.2 Typical Reverse Characteristics

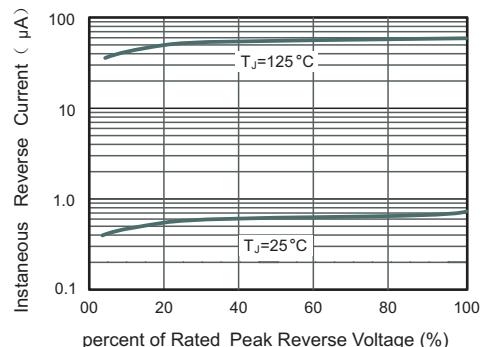
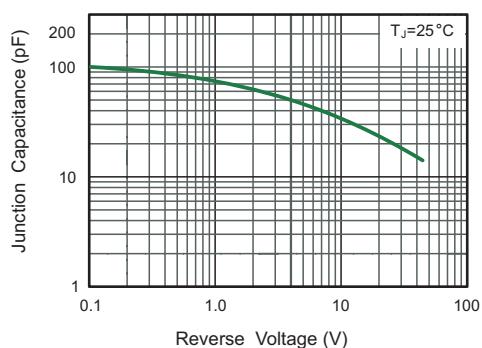


Fig.4 Typical Junction Capacitance

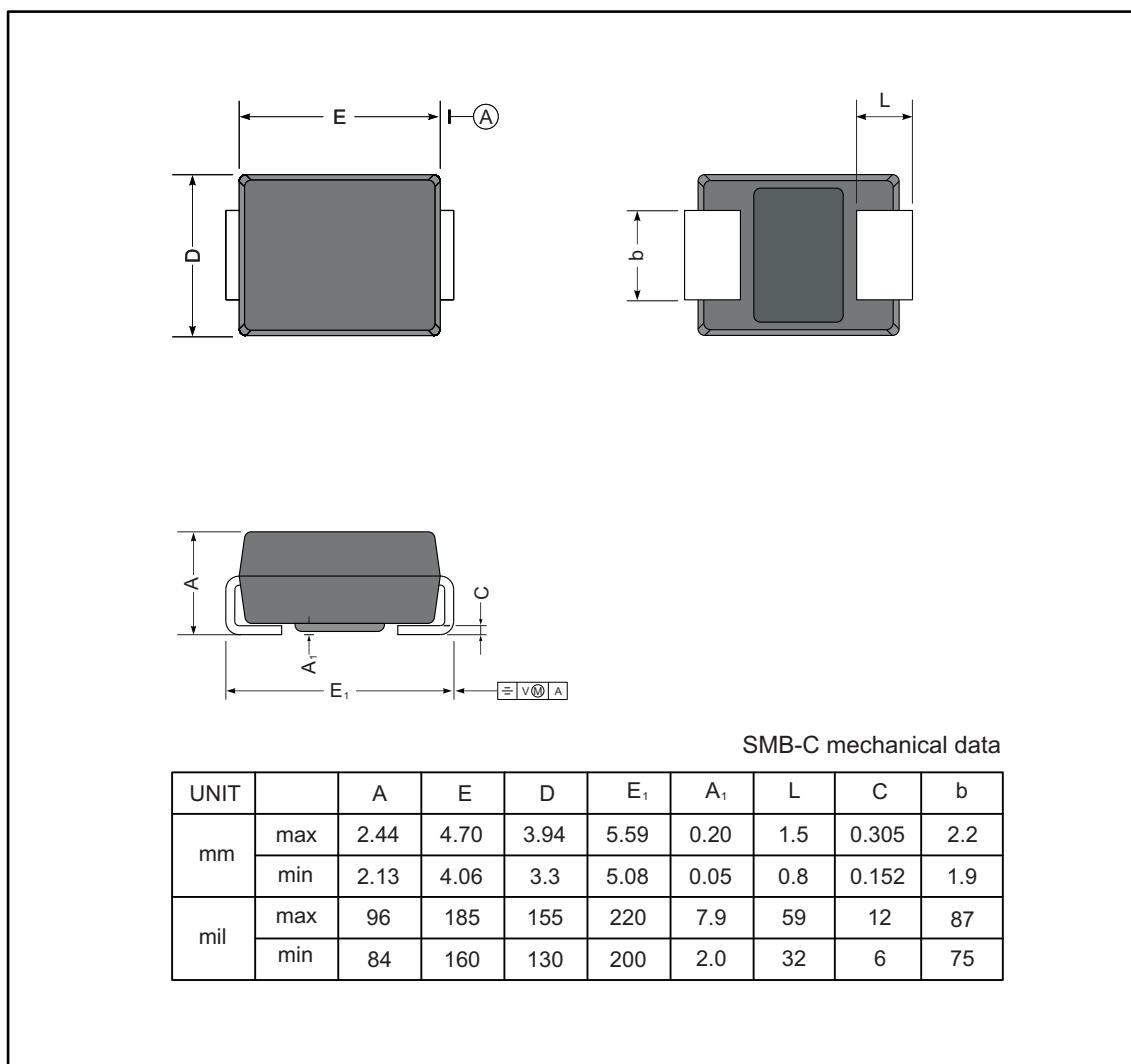




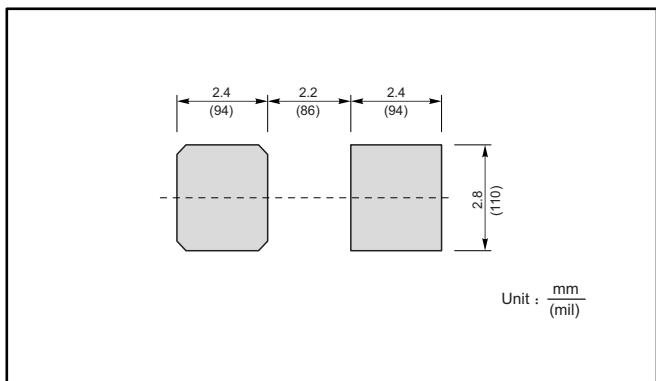
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMB-C



The recommended mounting pad size



Marking

Type number	Marking code
S5ABC	S5A
S5BBC	S5B
S5DBC	S5D
S5GBC	S5G
S5JBC	S5J
S5KBC	S5K
S5MBC	S5M



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